

SMD Comm COG Flex, Ceramic, 0.22 uF, 2%, 50 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1812



Dimensions	
Chip Size	1812
L	4.5mm +/-0.4mm
W	3.2mm +/-0.3mm
T	1.6mm +/-0.20mm
B	0.7mm +/-0.35mm

Packaging Specifications	
Packaging:	Bulk, Bag
Packaging Quantity:	1

General Information	
Series:	SMD Comm COG Flex
Style:	SMD Chip
Description:	SMD, MLCC, FT-CAP, Ultra-Stable
Features:	FT-CAP, Ultra-Stable
RoHS:	Yes
Termination:	Flexible Termination
Marking:	No
AEC-Q200:	No
Component Weight:	87 mg
Shelf Life:	78 Weeks
MSL:	1

Specifications	
Capacitance:	0.22 uF
Measurement Condition:	1 kHz 1.0Vrms
Capacitance Tolerance:	2%
Voltage DC:	50 VDC
Dielectric Withstanding Voltage:	125 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor:	0.1% 1 kHz 1.0Vrms
Aging Rate:	0% Loss/Decade Hour
Insulation Resistance:	4.5455 GOhms

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